Unit: mm



TOSHIBA Diode Silicon Epitaxial Planar Type

1SS403

High Voltage Switching Applications

AEC-Q101 Qualified (Note1)

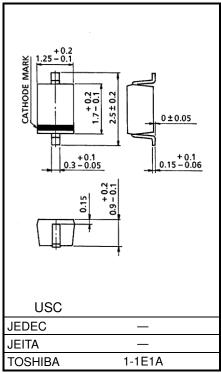
• Two-pin small packages are suitable for higher mounting densities.

Excellent in forward current and forward voltage characteristics : VF (2) = 0.90 V (typ.)
 Fast reverse recovery time : trr = 60 ns (max)
 Small total capacitance : CT = 1.5 pF (typ.)

Note1: For detail information, please contact our sales.

Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	V_{RM}	250	V	
Reverse voltage	VR	200	٧	
Maximum (peak) forward current	lғм	300	mA	
Average forward current	lo	100	mA	
Surge current (10ms)	IFSM	2	Α	
Power dissipation	P _D (Note 4)	200	mW	
Junction temperature	Tj (Note 2)	150	°C	
	T _j (Note 3)	125	C	
Storage temperature range	T _{stg} (Note 2)	−55 to 150	°C	
	T _{stg} (Note 3)	−55 to 125		



Weight: 0.0045g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: For devices with the ordering part number ending in H3F(T.

Note 3: For devices with the ordering part number in other than H3F(T.

Note 4: Mounted on a glass epoxy circuit board of 20 mm × 20 mm, Pad dimension of 4 mm × 4 mm.

Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	VF (1)	IF = 10 mA	_	0.72	1.0	V
	VF (2)	IF = 100 mA	_	0.90	1.2	
Reverse current —	I _{R (1)}	V _R = 50 V	_	_	0.1	μА
	I _{R (2)}	V _R = 200 V	_	_	1.0	
Total capacitance	Ст	V _R = 0 V, f = 1 MHz	_	1.5	3.0	pF
Reverse recovery time	t _{rr}	IF = 10 mA (Fig. 1)	_	10	60	ns

Start of commercial production 1998-10



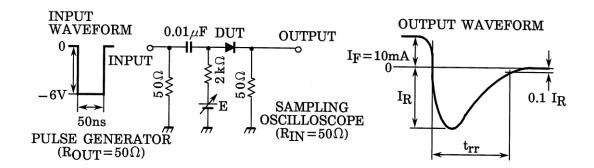
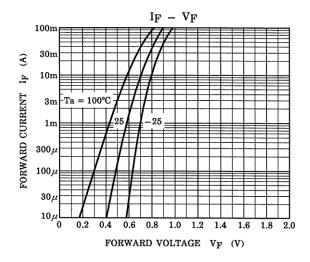


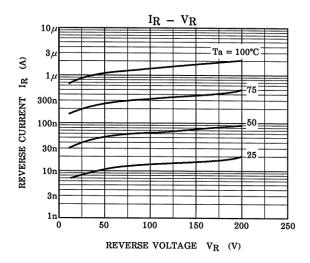
Fig.1 Reverse Recovery Time (trr) Test Circuit

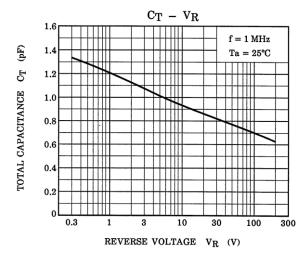


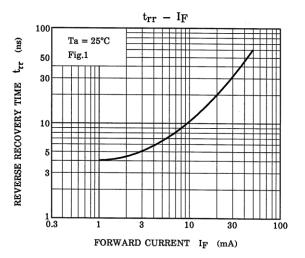


Characteristics Curves









The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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